

### FEATURES

Enhanced system-level ESD performance per IEC 61000-4-x

**Safety and regulatory approvals** (RI-16 package)

UL recognition: 5000 V rms for 1 minute per UL 1577

CSA Component Acceptance Notice #5A

IEC 60601-1: 250 V rms (reinforced)

IEC 60950-1: 400 V rms (reinforced)

VDE Certificate of Conformity

DIN V VDE V 0884-10 (VDE V 0884-10):2006-12

$V_{IORM} = 846$  V peak

Low power operation

5 V operation

1.4 mA per channel maximum @ 0 Mbps to 2 Mbps

4.3 mA per channel maximum @ 10 Mbps

34 mA per channel maximum @ 90 Mbps

3 V operation

0.9 mA per channel maximum @ 0 Mbps to 2 Mbps

2.4 mA per channel maximum @ 10 Mbps

20 mA per channel maximum @ 90 Mbps

Bidirectional communication

3 V/5 V level translation

High temperature operation: 105°C

High data rate: dc to 90 Mbps (NRZ)

Precise timing characteristics

2 ns maximum pulse width distortion

2 ns maximum channel-to-channel matching

High common-mode transient immunity: >25 kV/ $\mu$ s

Output enable function

16-lead SOIC wide body package version (RW-16)

16-lead SOIC wide body enhanced creepage version (RI-16)

### APPLICATIONS

General-purpose, high voltage, multichannel isolation

Medical equipment

Motor drives

Power supplies

### GENERAL DESCRIPTION

The ADuM440x<sup>1</sup> are 4-channel digital isolators based on the Analog Devices, Inc., *iCoupler*® technology. Combining high speed CMOS and monolithic air core transformer technology, these isolation components provide outstanding performance characteristics that are superior to the alternatives, such as optocoupler devices and other integrated couplers.

The ADuM440x isolators provide four independent isolation channels in a variety of channel configurations and data rates (see the Ordering Guide). All models operate with the supply voltage on either side ranging from 2.7 V to 5.5 V, providing compatibility with lower voltage systems as well as enabling a voltage translation functionality across the isolation barrier. The ADuM440x isolators have a patented refresh feature that ensures dc correctness in the absence of input logic transitions and during power-up/power-down conditions.

This family of isolators, like many Analog Devices isolators, offers very low power consumption, consuming one-tenth to one-sixth the power of comparable isolators at comparable data rates up to 10 Mbps. All models of the ADuM440x provide low pulse width distortion (<2 ns for C grade). In addition, every model has an input glitch filter to protect against extraneous noise disturbances.

The ADuM440x contain circuit and layout enhancements to help achieve system-level IEC 61000-4-x compliance (ESD/burst/surge). The precise capability in these tests for the ADuM440x are strongly determined by the design and layout of the user's board or module. For more information, see the AN-793 Application Note, *ESD/Latch-Up Considerations with iCoupler Isolation Products*.

<sup>1</sup> Protected by U.S. Patents 5,952,849; 6,873,065; and 7,075,329.

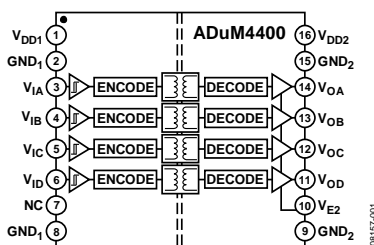


Figure 1. ADuM4400

### FUNCTIONAL BLOCK DIAGRAMS



Figure 2. ADuM4401

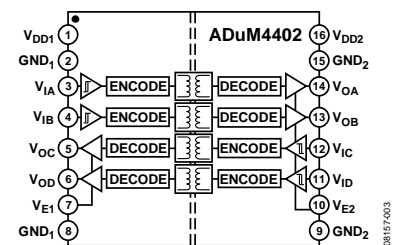


Figure 3. ADuM4402

### Rev. C

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## REVISION HISTORY

### 2/12—Rev. B to Rev. C

Created Hyperlink for Safety and Regulatory Approvals	
Entry in Features Section.....	1
Change to PC Board Layout Section.....	15

### 10/11—Rev. A to Rev. B

Added Logic Low Output Voltage, Table 3 .....	3
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Added Logic Low Output Voltage, Table 9 .....	5
Added Logic Low Output Voltage, Table 12 .....	6

### 8/11—Rev. 0 to Rev. A

Added 16-Lead SOIC_IC Package .....	Universal
Changes to Features Section.....	1
Changes to Pulse Width Parameter, C Grade, Table 1.....	3
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Changes to Table 14 and Table 15 .....	7
Deleted (Pending) Throughout .....	8
Changes to Endnote 1, Table 17.....	8
Updated Outline Dimensions .....	18
Changes to Ordering Guide .....	19

### 4/09—Revision 0: Initial Version

## SPECIFICATIONS

## ELECTRICAL CHARACTERISTICS—5 V OPERATION

All typical specifications are at  $T_A = 25^\circ\text{C}$ ,  $V_{DD1} = V_{DD2} = 5\text{ V}$ . Minimum/maximum specifications apply over the entire recommended operation range of  $4.5\text{ V} \leq V_{DD1} \leq 5.5\text{ V}$ ,  $4.5\text{ V} \leq V_{DD2} \leq 5.5\text{ V}$ , and  $-40^\circ\text{C} \leq T_A \leq 105^\circ\text{C}$ , unless otherwise noted. Switching specifications are tested with  $C_L = 15\text{ pF}$  and CMOS signal levels, unless otherwise noted.

Table 1.

Parameter	Symbol	A Grade			B Grade			C Grade			Unit	Test Conditions
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SWITCHING SPECIFICATIONS												
Data Rate				1			10			90	Mbps	Within PWD limit
Propagation Delay	$t_{PHL}$ , $t_{PLH}$	50	65	100	20	32	50	18	27	32	ns	50% input to 50% output
Pulse Width Distortion	PWD			40			3		0.5	2	ns	$ t_{PLH} - t_{PHL} $
Change vs. Temperature			11			5			3		ps/°C	
Pulse Width	PW	1000			100			11.1			ns	Within PWD limit
Propagation Delay Skew	$t_{PSK}$			50			15			10	ns	Between any two units
Channel Matching												
Codirectional	$t_{PSKCD}$			50			3			2	ns	
Opposing-Direction	$t_{PSKOD}$			50			6			5	ns	

Table 2.

Parameter	Symbol	1 Mbps—A, B, C Grades			10 Mbps—B, C Grades			90 Mbps—C Grade			Unit	Test Conditions
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SUPPLY CURRENT												
ADuM4400	$I_{DD1}$	2.9	3.5		9.0	11.6		72	100		mA	
	$I_{DD2}$	1.2	1.9		3.0	5.5		19	36		mA	
ADuM4401	$I_{DD1}$	2.5	3.2		7.4	10.6		59	82		mA	
	$I_{DD2}$	1.6	2.4		4.4	6.5		32	46		mA	
ADuM4402	$I_{DD1}$	2.0	2.8		6.0	7.5		51	62		mA	
	$I_{DD2}$	2.0	2.8		6.0	7.5		51	62		mA	

Table 3. For All Models

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
DC SPECIFICATIONS						
Logic High Input Threshold	$V_{IH}$	2.0			V	
Logic Low Input Threshold	$V_{IL}$			0.8	V	
Logic High Output Voltage	$V_{OH}$	$V_{DDx} - 0.1$	5.0		V	$I_{Ox} = -20\text{ }\mu\text{A}$ , $V_{Ix} = V_{IxH}$
		$V_{DDx} - 0.4$	4.8		V	$I_{Ox} = -4\text{ mA}$ , $V_{Ix} = V_{IxH}$
Logic Low Output Voltage	$V_{OL}$		0.0	0.1	V	$I_{Ox} = 20\text{ }\mu\text{A}$ , $V_{Ix} = V_{IxL}$
			0.04	0.1	V	$I_{Ox} = 400\text{ }\mu\text{A}$ , $V_{Ix} = V_{IxL}$
			0.2	0.4	V	$I_{Ox} = 4\text{ mA}$ , $V_{Ix} = V_{IxL}$
Input Current per Channel	$I_i$	-10	+0.01	+10	$\mu\text{A}$	$0\text{ V} \leq V_{Ix} \leq V_{DDx}$
Supply Current per Channel						
Quiescent Input Supply Current	$I_{DDI(Q)}$		0.57	0.83	mA	
Quiescent Output Supply Current	$I_{DDO(Q)}$		0.23	0.35	mA	
Dynamic Input Supply Current	$I_{DDI(D)}$		0.20		mA/Mbps	
Dynamic Output Supply Current	$I_{DDO(D)}$		0.05		mA/Mbps	
AC SPECIFICATIONS						
Output Rise/Fall Time	$t_R/t_F$		2.5		ns	10% to 90%
Common-Mode Transient Immunity <sup>1</sup>	$ CM $	25	35		kV/ $\mu\text{s}$	$V_{Ix} = V_{DDx}$ , $V_{CM} = 1000\text{ V}$ , transient magnitude = 800 V
Output Disable Propagation Delay	$t_{PHZ}$ , $t_{PLH}$		6	8	ns	High/low-to-high impedance
Output Enable Propagation Delay	$t_{PZH}$ , $t_{PZL}$		6	8	ns	High impedance-to-high/low
Refresh Rate	$f_r$		1.2		Mbps	

<sup>1</sup>  $|CM|$  is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_o > 0.8 V_{DD}$ . The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

**ELECTRICAL CHARACTERISTICS—3 V OPERATION**

All typical specifications are at  $T_A = 25^\circ\text{C}$ ,  $V_{DD1} = V_{DD2} = 3.0\text{ V}$ . Minimum/maximum specifications apply over the entire recommended operation range:  $2.7\text{ V} \leq V_{DD1} \leq 3.6\text{ V}$ ,  $2.7\text{ V} \leq V_{DD2} \leq 3.6\text{ V}$ , and  $-40^\circ\text{C} \leq T_A \leq 105^\circ\text{C}$ , unless otherwise noted. Switching specifications are tested with  $C_L = 15\text{ pF}$  and CMOS signal levels, unless otherwise noted.

**Table 4.**

Parameter	Symbol	A Grade			B Grade			C Grade			Unit	Test Conditions
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SWITCHING SPECIFICATIONS												
Data Rate				1			10			90	Mbps	Within PWD limit
Propagation Delay	$t_{PHL}, t_{PLH}$	50	75	100	20	38	50	20	34	45	ns	50% input to 50% output
Pulse Width Distortion	PWD			40			3		0.5	2	ns	$ t_{PLH} - t_{PHL} $
Change vs. Temperature			11			5			3		ps/°C	
Pulse Width	PW	1000			100			11.1			ns	Within PWD limit
Propagation Delay Skew	$t_{PSK}$			50			22			16	ns	Between any two units
Channel Matching												
Codirectional	$t_{PSKCD}$			50			3			2	ns	
Opposing-Direction	$t_{PSKOD}$			50			6			5	ns	

**Table 5.**

Parameter	Symbol	1 Mbps—A, B, C Grades			10 Mbps—B, C Grades			90 Mbps—C Grade			Unit	Test Conditions
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SUPPLY CURRENT												
ADuM4400	$I_{DD1}$		1.6	2.1		4.8	7.1		37	54	mA	
	$I_{DD2}$		0.7	1.2		1.8	2.3		11	15	mA	
ADuM4401	$I_{DD1}$		1.4	1.9		0.1	5.6		31	44	mA	
	$I_{DD2}$		0.9	1.5		2.5	3.3		17	24	mA	
ADuM4402	$I_{DD1}$		1.2	1.7		3.3	4.4		24	39	mA	
	$I_{DD2}$		1.2	1.7		3.3	4.4		24	39	mA	

**Table 6. For All Models**

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
DC SPECIFICATIONS						
Logic High Input Threshold	$V_{IH}$	1.6			V	
Logic Low Input Threshold	$V_{IL}$			0.4	V	
Logic High Output Voltage	$V_{OH}$	$V_{DDx} - 0.1$	3.0		V	$I_{Ox} = -20\text{ }\mu\text{A}$ , $V_{Ix} = V_{IxH}$
		$V_{DDx} - 0.4$	2.8		V	$I_{Ox} = -4\text{ mA}$ , $V_{Ix} = V_{IxH}$
Logic Low Output Voltage	$V_{OL}$		0.0	0.1	V	$I_{Ox} = 20\text{ }\mu\text{A}$ , $V_{Ix} = V_{IxL}$
			0.04	0.1	V	$I_{Ox} = 400\text{ }\mu\text{A}$ , $V_{Ix} = V_{IxL}$
			0.2	0.4	V	$I_{Ox} = 4\text{ mA}$ , $V_{Ix} = V_{IxL}$
Input Current per Channel	$I_i$	-10	+0.01	+10	$\mu\text{A}$	$0\text{ V} \leq V_{Ix} \leq V_{DDx}$
Supply Current per Channel						
Quiescent Input Supply Current	$I_{DDI(Q)}$		0.31	0.49	mA	
Quiescent Output Supply Current	$I_{DDO(Q)}$		0.19	0.27	mA	
Dynamic Input Supply Current	$I_{DDI(D)}$		0.10		mA/Mbps	
Dynamic Output Supply Current	$I_{DDO(D)}$		0.03		mA/Mbps	
AC SPECIFICATIONS						
Output Rise/Fall Time	$t_R/t_F$		3		ns	10% to 90%
Common-Mode Transient Immunity <sup>1</sup>	$ CM $	25	35		kV/ $\mu\text{s}$	$V_{Ix} = V_{DDx}$ , $V_{CM} = 1000\text{ V}$ , transient magnitude = 800 V
Output Disable Propagation Delay	$t_{PHZ}, t_{PLH}$		6	8	ns	High/low-to-high impedance
Output Enable Propagation Delay	$t_{PZH}, t_{PZL}$		6	8	ns	High impedance-to-high/low
Refresh Rate	$f_r$		1.2		Mbps	

<sup>1</sup>  $|CM|$  is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_O > 0.8 V_{DD}$ . The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

**ELECTRICAL CHARACTERISTICS—MIXED 5 V/3 V OPERATION**

All typical specifications are at  $T_A = 25^\circ\text{C}$ ,  $V_{DD1} = 5\text{ V}$ ,  $V_{DD2} = 3.0\text{ V}$ . Minimum/maximum specifications apply over the entire recommended operation range:  $4.5\text{ V} \leq V_{DD1} \leq 5.5\text{ V}$ ,  $2.7\text{ V} \leq V_{DD2} \leq 3.6\text{ V}$ , and  $-40^\circ\text{C} \leq T_A \leq 105^\circ\text{C}$ , unless otherwise noted. Switching specifications are tested with  $C_L = 15\text{ pF}$  and CMOS signal levels, unless otherwise noted.

**Table 7.**

Parameter	Symbol	A Grade			B Grade			C Grade			Unit	Test Conditions
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SWITCHING SPECIFICATIONS												
Data Rate				1			10			90	Mbps	Within PWD limit
Propagation Delay	$t_{PHL}, t_{PLH}$	50	70	50	15	35	50	20	30	40	ns	50% input to 50% output
Pulse Width Distortion	PWD			40			3		0.5	2	ns	$ t_{PLH} - t_{PHL} $
Change vs. Temperature			11			5			3		ps/°C	
Pulse Width	PW	1000			100			11.1			ns	Within PWD limit
Propagation Delay Skew	$t_{PSK}$			50			22			14	ns	Between any two units
Channel Matching												
Codirectional	$t_{PSKCD}$			50			3			2	ns	
Opposing-Direction	$t_{PSKOD}$			50			6			5	ns	

**Table 8.**

Parameter	Symbol	1 Mbps—A, B, C Grades			10 Mbps—B, C Grades			90 Mbps—C Grade			Unit	Test Conditions
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SUPPLY CURRENT												
ADuM4400	$I_{DD1}$		2.9	3.5		9.0	11.6		72	100	mA	
	$I_{DD2}$		0.7	1.2		1.8	2.3		11	15	mA	
ADuM4401	$I_{DD1}$		2.5	3.2		7.4	10.6		59	82	mA	
	$I_{DD2}$		0.9	1.5		2.5	3.3		17	24	mA	
ADuM4402	$I_{DD1}$		2.0	2.8		6.0	7.5		46	62	mA	
	$I_{DD2}$		1.2	1.7		3.3	4.4		24	39	mA	

**Table 9. For All Models**

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
DC SPECIFICATIONS						
Logic High Input Threshold	$V_{IH}$	2.0			V	
Logic Low Input Threshold	$V_{IL}$			0.8	V	
Logic High Output Voltage	$V_{OH}$	$V_{DDx} - 0.1$	3.0		V	$I_{Ox} = -20\text{ }\mu\text{A}$ , $V_{Ix} = V_{IxH}$
		$V_{DDx} - 0.4$	2.8		V	$I_{Ox} = -4\text{ mA}$ , $V_{Ix} = V_{IxH}$
Logic Low Output Voltage	$V_{OL}$		0.0	0.1	V	$I_{Ox} = 20\text{ }\mu\text{A}$ , $V_{Ix} = V_{IxL}$
			0.04	0.1	V	$I_{Ox} = 400\text{ }\mu\text{A}$ , $V_{Ix} = V_{IxL}$
			0.2	0.4	V	$I_{Ox} = 4\text{ mA}$ , $V_{Ix} = V_{IxL}$
Input Current per Channel	$I_i$	-10	+0.01	+10	$\mu\text{A}$	$0\text{ V} \leq V_{Ix} \leq V_{DDx}$
Supply Current per Channel						
Quiescent Input Supply Current	$I_{DD1(Q)}$		0.57	0.83	mA	
Quiescent Output Supply Current	$I_{DD0(Q)}$		0.29	0.27	mA	
Dynamic Input Supply Current	$I_{DD1(D)}$		0.20		mA/Mbps	
Dynamic Output Supply Current	$I_{DD0(D)}$		0.03		mA/Mbps	
AC SPECIFICATIONS						
Output Rise/Fall Time	$t_R/t_F$		3		ns	10% to 90%
Common-Mode Transient Immunity <sup>1</sup>	$ CM $	25	35		kV/ $\mu\text{s}$	$V_{Ix} = V_{DDx}$ , $V_{CM} = 1000\text{ V}$ , transient magnitude = 800 V
Output Disable Propagation Delay	$t_{PHZ}, t_{PLH}$		6	8	ns	High/low-to-high impedance
Output Enable Propagation Delay	$t_{PZH}, t_{PZL}$		6	8	ns	High impedance-to-high/low
Refresh Rate	$f_r$		1.2		Mbps	

<sup>1</sup>  $|CM|$  is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_o > 0.8 V_{DD}$ . The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

**ELECTRICAL CHARACTERISTICS—MIXED 3 V/5 V OPERATION**

All typical specifications are at  $T_A = 25^\circ\text{C}$ ,  $V_{DD1} = 3.0\text{ V}$ ,  $V_{DD2} = 5\text{ V}$ . Minimum/maximum specifications apply over the entire recommended operation range:  $2.7\text{ V} \leq V_{DD1} \leq 3.6\text{ V}$ ,  $4.5\text{ V} \leq V_{DD2} \leq 5.5\text{ V}$ , and  $-40^\circ\text{C} \leq T_A \leq +105^\circ\text{C}$ , unless otherwise noted. Switching specifications are tested with  $C_L = 15\text{ pF}$  and CMOS signal levels, unless otherwise noted.

**Table 10.**

Parameter	Symbol	A Grade			B Grade			C Grade			Unit	Test Conditions
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SWITCHING SPECIFICATIONS												
Data Rate				1			10			90	Mbps	Within PWD limit
Propagation Delay	$t_{PHL}$ , $t_{PLH}$	50	70	100	15	35	50	20	30	40	ns	50% input to 50% output
Pulse Width Distortion	PWD			40			3		0.5	2	ns	$ t_{PLH} - t_{PHL} $
Change vs. Temperature			11			5			3		ps/ $^\circ\text{C}$	
Pulse Width	PW	1000			100			11.1			ns	Within PWD limit
Propagation Delay Skew	$t_{PSK}$			50			22			14	ns	Between any two units
Channel Matching												
Codirectional	$t_{PSKCD}$			50			3			2	ns	
Opposing-Direction	$t_{PSKOD}$			50			6			5	ns	

**Table 11.**

Parameter	Symbol	1 Mbps—A, B, C Grades			10 Mbps—B, C Grades			90 Mbps—C Grade			Unit	Test Conditions
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
SUPPLY CURRENT												
ADuM4400	$I_{DD1}$	1.6	2.1		4.8	7.1		37	54		mA	
	$I_{DD2}$	1.2	1.9		3.0	5.5		19	36		mA	
ADuM4401	$I_{DD1}$	1.4	1.9		4.1	5.6		31	44		mA	
	$I_{DD2}$	1.6	2.4		4.4	6.5		32	46		mA	
ADuM4402	$I_{DD1}$	1.2	1.7		3.3	4.4		24	39		mA	
	$I_{DD2}$	2.0	2.8		6.0	7.5		46	62		mA	

**Table 12. For All Models**

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
DC SPECIFICATIONS						
Logic High Input Threshold	$V_{IH}$	1.6			V	
Logic Low Input Threshold	$V_{IL}$			0.4	V	
Logic High Output Voltage	$V_{OH}$	$V_{DDx} - 0.1$	5.0		V	$I_{Ox} = -20\text{ }\mu\text{A}$ , $V_{Ix} = V_{IxH}$
		$V_{DDx} - 0.4$	4.8		V	$I_{Ox} = -4\text{ mA}$ , $V_{Ix} = V_{IxH}$
Logic Low Output Voltage	$V_{OL}$		0.0	0.1	V	$I_{Ox} = 20\text{ }\mu\text{A}$ , $V_{Ix} = V_{IxL}$
			0.04	0.1	V	$I_{Ox} = 400\text{ }\mu\text{A}$ , $V_{Ix} = V_{IxL}$
			0.2	0.4	V	$I_{Ox} = 4\text{ mA}$ , $V_{Ix} = V_{IxL}$
Input Current per Channel	$I_i$	-10	+0.01	+10	$\mu\text{A}$	$0\text{ V} \leq V_{Ix} \leq V_{DDx}$
Supply Current per Channel						
Quiescent Input Supply Current	$I_{DD1(Q)}$		0.31	0.49	mA	
Quiescent Output Supply Current	$I_{DD2(Q)}$		0.19	0.35	mA	
Dynamic Input Supply Current	$I_{DD1(D)}$		0.10		mA/Mbps	
Dynamic Output Supply Current	$I_{DD2(D)}$		0.05		mA/Mbps	
AC SPECIFICATIONS						
Output Rise/Fall Time	$t_R/t_F$		2.5		ns	10% to 90%
Common-Mode Transient Immunity <sup>1</sup>	$ CM $	25	35		kV/ $\mu\text{s}$	$V_{Ix} = V_{DDx}$ , $V_{CM} = 1000\text{ V}$ , transient magnitude = 800 V
Output Disable Propagation Delay	$t_{PHZ}$ , $t_{PLH}$		6	8	ns	High/low-to-high impedance
Output Enable Propagation Delay	$t_{PZH}$ , $t_{PZL}$		6	8	ns	High impedance-to-high/low
Refresh Rate	$f_r$		1.1		Mbps	

<sup>1</sup>  $|CM|$  is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_o > 0.8 V_{DD}$ . The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

**PACKAGE CHARACTERISTICS**

Table 13.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
Resistance (Input to Output) <sup>1</sup>	$R_{I-O}$		10 <sup>12</sup>		$\Omega$	f = 1 MHz
Capacitance (Input to Output) <sup>1</sup>	$C_{I-O}$		2.2		pF	
Input Capacitance <sup>2</sup>	$C_I$		4.0		pF	
IC Junction-to-Case Thermal Resistance, Side 1	$\theta_{JCI}$		33		$^{\circ}\text{C}/\text{W}$	Thermocouple located at center of package underside
IC Junction-to-Case Thermal Resistance, Side 2	$\theta_{JCO}$		28		$^{\circ}\text{C}/\text{W}$	

<sup>1</sup> Device considered a 2-terminal device: Pin 1, Pin 2, Pin 3, Pin 4, Pin 5, Pin 6, Pin 7, and Pin 8 shorted together and Pin 9, Pin 10, Pin 11, Pin 12, Pin 13, Pin 14, Pin 15, and Pin 16 shorted together.

<sup>2</sup> Input capacitance is from any input data pin to ground.

**REGULATORY INFORMATION**

The ADuM440x are approved by the organizations listed in Table 14. Refer to Table 19 and the Insulation Lifetime section for details regarding recommended maximum working voltages for specific cross-isolation waveforms and insulation levels.

Table 14.

UL	CSA	VDE
Recognized under 1577 Component Recognition Program <sup>1</sup>	Approved under CSA Component Acceptance Notice #5A	Certified according to DIN V VDE V 0884-10 (VDE V 0884-10): 2006-12 <sup>2</sup>
Single Protection 5000 V rms Isolation Voltage	Basic insulation per CSA 60950-1-07 and IEC 60950-1, 600 V rms (848 V peak) maximum working voltage RW-16 package: Reinforced insulation per CSA 60950-1-07 and IEC 60950-1, 380 V rms (537 V peak) maximum working voltage; reinforced insulation per IEC 60601-1 125 V rms (176 V peak) maximum working voltage RI-16 package: Reinforced insulation per CSA 60950-1-07 and IEC 60950-1, 400 V rms (565 V peak) maximum working voltage; reinforced insulation per IEC 60601-1 250 V rms (353 V peak) maximum working voltage	Reinforced insulation, 846 V peak
File E214100	File 205078	File 2471900-4880-0001

<sup>1</sup> In accordance with UL1577, each ADuM440x is proof tested by applying an insulation test voltage  $\geq 6000$  V rms for 1 second (current leakage detection limit = 10  $\mu\text{A}$ ).

<sup>2</sup> In accordance with DIN V VDE V 0884-10, each ADuM440x is proof tested by applying an insulation test voltage  $\geq 1590$  V peak for 1 sec (partial discharge detection limit = 5 pC). The \* marking branded on the component designates DIN V VDE V 0884-10 approval.

**INSULATION AND SAFETY-RELATED SPECIFICATIONS**

Table 15.

Parameter	Symbol	Value	Unit	Conditions
Rated Dielectric Insulation Voltage		5000	V rms	1-minute duration
Minimum External Air Gap	L(I01)	8.0 min	mm	Distance measured from input terminals to output terminals, shortest distance through air along the PCB mounting plane, as an aid to PC board layout
Minimum External Tracking (Creepage) RW-16 Package	L(I02)	7.7 min	mm	Measured from input terminals to output terminals, shortest distance path along body
Minimum External Tracking (Creepage) RI-16 Package	L(I02)	8.3 min	mm	Measured from input terminals to output terminals, shortest distance path along body
Minimum Internal Gap (Internal Clearance)		0.017 min	mm	Insulation distance through insulation
Tracking Resistance (Comparative Tracking Index)	CTI	>175	V	DIN IEC 112/VDE 0303 Part 1

**DIN V VDE V 0884-10 (VDE V 0884-10) INSULATION CHARACTERISTICS**

These isolators are suitable for reinforced electrical isolation only within the safety limit data. Maintenance of the safety data is ensured by means of protective circuits.

Note that the \* marking on packages denotes DIN V VDE V 0884-10 approval for 846 V peak working voltage.

**Table 16.**

Description	Conditions	Symbol	Characteristic	Unit
Installation Classification per DIN VDE 0110 For Rated Mains Voltage ≤ 300 V rms For Rated Mains Voltage ≤ 450 V rms For Rated Mains Voltage ≤ 600 V rms			I to IV I to II I to II	
Climatic Classification			40/105/21	
Pollution Degree (DIN VDE 0110, Table 1)			2	
Maximum Working Insulation Voltage		$V_{IORM}$	846	V peak
Input-to-Output Test Voltage, Method b1	$V_{IORM} \times 1.875 = V_{PR}$ , 100% production test, $t_m = 1$ sec, partial discharge < 5 pC	$V_{PR}$	1590	V peak
Input-to-Output Test Voltage, Method a		$V_{PR}$		
After Environmental Tests Subgroup 1	$V_{IORM} \times 1.6 = V_{PR}$ , $t_m = 60$ sec, partial discharge < 5 pC		1375	V peak
After Input and/or Safety Test Subgroup 2 and Subgroup 3	$V_{IORM} \times 1.2 = V_{PR}$ , $t_m = 60$ sec, partial discharge < 5 pC		1018	V peak
Highest Allowable Overvoltage	Transient overvoltage, $t_{TR} = 10$ seconds	$V_{TR}$	6000	V peak
Safety-Limiting Values	Maximum value allowed in the event of a failure; see Figure 4			
Case Temperature		$T_S$	150	°C
Side 1 Current		$I_{S1}$	265	mA
Side 2 Current		$I_{S2}$	335	mA
Insulation Resistance at $T_S$	$V_{IO} = 500$ V	$R_S$	>10 <sup>9</sup>	Ω



Figure 4. Thermal Derating Curve, Dependence of Safety Limiting Values with Case Temperature per DIN V VDE V 0884-10

**RECOMMENDED OPERATING CONDITIONS**

**Table 17.**

Parameter	Symbol	Min	Max	Unit
Operating Temperature	$T_A$	-40	+105	°C
Supply Voltages <sup>1</sup>	$V_{DD1}, V_{DD2}$	2.7	5.5	V
Input Signal Rise and Fall Times			1.0	ms

<sup>1</sup> All voltages are relative to their respective ground.



## ABSOLUTE MAXIMUM RATINGS

Table 18.

Parameter	Rating
Storage Temperature ( $T_{ST}$ )	-65°C to +150°C
Ambient Operating Temperature ( $T_A$ )	-40°C to +105°C
Supply Voltages ( $V_{DD1}$ , $V_{DD2}$ ) <sup>1</sup>	-0.5 V to +7.0 V
Input Voltage ( $V_{IA}$ , $V_{IB}$ , $V_{IC}$ , $V_{ID}$ , $V_{E1}$ , $V_{E2}$ ) <sup>1,2</sup>	-0.5 V to $V_{DD1} + 0.5$ V
Output Voltage ( $V_{OA}$ , $V_{OB}$ , $V_{OC}$ , $V_{OD}$ ) <sup>1,2</sup>	-0.5 V to $V_{DD0} + 0.5$ V
Average Output Current Per Pin <sup>3</sup>	
Side 1 ( $I_{O1}$ )	-18 mA to +18 mA
Side 2 ( $I_{O2}$ )	-22 mA to +22 mA
Common-Mode Transients <sup>4</sup>	-100 kV/ $\mu$ s to +100 kV/ $\mu$ s

<sup>1</sup> All voltages are relative to their respective ground.

<sup>2</sup>  $V_{DD1}$  and  $V_{DD0}$  refer to the supply voltages on the input and output sides of a given channel, respectively. See the PC Board Layout section.

<sup>3</sup> See Figure 4 for maximum rated current values for various temperatures.

<sup>4</sup> Refers to common-mode transients across the insulation barrier. Common-mode transients exceeding the Absolute Maximum Rating can cause latch-up or permanent damage.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

Table 19. Maximum Continuous Working Voltage<sup>1</sup>

Parameter	Max	Unit	Constraint
AC Voltage, Bipolar Waveform	565	V peak	50 year minimum lifetime
AC Voltage, Unipolar Waveform			
Reinforced Insulation	846	V peak	Maximum approved working voltage per IEC 60950-1 and VDE V 0884-10
DC Voltage			
Reinforced Insulation	846	V peak	Maximum approved working voltage per IEC 60950-1 and VDE V 0884-10

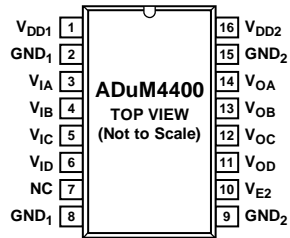
<sup>1</sup> Refers to continuous voltage magnitude imposed across the isolation barrier. See the Insulation Lifetime section for more details.

Table 20. Truth Table (Positive Logic)

$V_{IX}$ Input <sup>1</sup>	$V_{EX}$ Input	$V_{DD1}$ State <sup>1</sup>	$V_{DD0}$ State <sup>1</sup>	$V_{OX}$ Output <sup>1</sup>	Notes
H	H or NC	Powered	Powered	H	
L	H or NC	Powered	Powered	L	
X	L	Powered	Powered	Z	
X	H or NC	Unpowered	Powered	H	Outputs return to input state within 1 $\mu$ s of $V_{DD1}$ power restoration.
X	L	Unpowered	Powered	Z	
X	X	Powered	Unpowered	Indeterminate	Outputs return to input state within 1 $\mu$ s of $V_{DD0}$ power restoration if $V_{EX}$ state is H or NC. Outputs return to high impedance state within 8 ns of $V_{DD0}$ power restoration if $V_{EX}$ state is L.

<sup>1</sup>  $V_{IX}$  and  $V_{OX}$  refer to the input and output signals of a given channel (A, B, C, or D).  $V_{EX}$  refers to the output enable signal on the same side as the  $V_{OX}$  outputs.  $V_{DD1}$  and  $V_{DD0}$  refer to the supply voltages on the input and output sides of the given channel, respectively.

## PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS



## NOTES

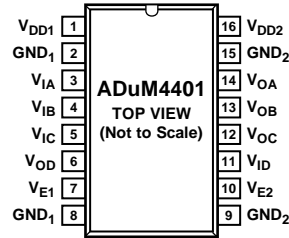
1. NC = NO CONNECT
2. PIN 2 AND PIN 8 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND<sub>1</sub> IS RECOMMENDED.
3. PIN 9 AND PIN 15 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND<sub>2</sub> IS RECOMMENDED.

08157-005

Figure 5. ADuM4400 Pin Configuration

Table 21. ADuM4400 Pin Function Descriptions

Pin No.	Mnemonic	Description
1	V <sub>DD1</sub>	Supply Voltage for Isolator Side 1, 2.7 V to 5.5 V.
2	GND <sub>1</sub>	Ground 1. Ground reference for isolator Side 1.
3	V <sub>IA</sub>	Logic Input A.
4	V <sub>IB</sub>	Logic Input B.
5	V <sub>IC</sub>	Logic Input C.
6	V <sub>ID</sub>	Logic Input D.
7	NC	No Connect.
8	GND <sub>1</sub>	Ground 1. Ground reference for isolator Side 1.
9	GND <sub>2</sub>	Ground 2. Ground reference for isolator Side 2.
10	V <sub>E2</sub>	Output Enable 2. Active high logic input. V <sub>Ox</sub> outputs on Side 2 are enabled when V <sub>E2</sub> is high or disconnected. V <sub>Ox</sub> Side 2 outputs are disabled when V <sub>E2</sub> is low. In noisy environments, connecting V <sub>E2</sub> to an external logic high or low is recommended.
11	V <sub>OD</sub>	Logic Output D.
12	V <sub>OC</sub>	Logic Output C.
13	V <sub>OB</sub>	Logic Output B.
14	V <sub>OA</sub>	Logic Output A.
15	GND <sub>2</sub>	Ground 2. Ground reference for isolator Side 2.
16	V <sub>DD2</sub>	Supply Voltage for Isolator Side 2, 2.7 V to 5.5 V.



## NOTES

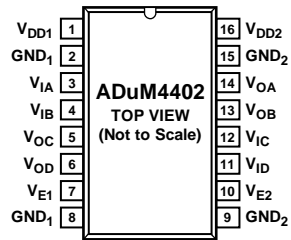
1. PIN 2 AND PIN 8 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND<sub>1</sub> IS RECOMMENDED.
2. PIN 9 AND PIN 15 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND<sub>2</sub> IS RECOMMENDED.

09157-006

Figure 6. ADuM4401 Pin Configuration

Table 22. ADuM4401 Pin Function Descriptions

Pin No.	Mnemonic	Description
1	V <sub>DD1</sub>	Supply Voltage for Isolator Side 1, 2.7 V to 5.5 V.
2	GND <sub>1</sub>	Ground 1. Ground reference for isolator Side 1.
3	V <sub>IA</sub>	Logic Input A.
4	V <sub>IB</sub>	Logic Input B.
5	V <sub>IC</sub>	Logic Input C.
6	V <sub>OD</sub>	Logic Output D.
7	V <sub>E1</sub>	Output Enable. Active high logic input. V <sub>OX</sub> Side 1 outputs are enabled when V <sub>E1</sub> is high or disconnected. V <sub>OX</sub> Side 1 outputs are disabled when V <sub>E1</sub> is low. In noisy environments, connecting V <sub>E1</sub> to an external logic high or low is recommended.
8	GND <sub>1</sub>	Ground 1. Ground reference for isolator Side 1.
9	GND <sub>2</sub>	Ground 2. Ground reference for isolator Side 2.
10	V <sub>E2</sub>	Output Enable 2. Active high logic input. V <sub>OX</sub> outputs on Side 2 are enabled when V <sub>E2</sub> is high or disconnected. V <sub>OX</sub> Side 2 outputs are disabled when V <sub>E2</sub> is low. In noisy environments, connecting V <sub>E2</sub> to an external logic high or low is recommended.
11	V <sub>ID</sub>	Logic Input D.
12	V <sub>OC</sub>	Logic Output C.
13	V <sub>OB</sub>	Logic Output B.
14	V <sub>OA</sub>	Logic Output A.
15	GND <sub>2</sub>	Ground 2. Ground reference for isolator Side 2.
16	V <sub>DD2</sub>	Supply Voltage for Isolator Side 2, 2.7 V to 5.5 V.



## NOTES

1. PIN 2 AND PIN 8 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND<sub>1</sub> IS RECOMMENDED.
2. PIN 9 AND PIN 15 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND<sub>2</sub> IS RECOMMENDED.

08157-007

Figure 7. ADuM4402 Pin Configuration

Table 23. ADuM4402 Pin Function Descriptions

Pin No.	Mnemonic	Description
1	V <sub>DD1</sub>	Supply Voltage for Isolator Side 1, 2.7 V to 5.5 V.
2	GND <sub>1</sub>	Ground 1. Ground reference for isolator Side 1.
3	V <sub>IA</sub>	Logic Input A.
4	V <sub>IB</sub>	Logic Input B.
5	V <sub>OC</sub>	Logic Output C.
6	V <sub>OD</sub>	Logic Output D.
7	V <sub>E1</sub>	Output Enable 1. Active high logic input. V <sub>Ox</sub> Side 1 outputs are enabled when V <sub>E1</sub> is high or disconnected. V <sub>Ox</sub> Side 1 outputs are disabled when V <sub>E1</sub> is low. In noisy environments, connecting V <sub>E1</sub> to an external logic high or low is recommended.
8	GND <sub>1</sub>	Ground 1. Ground reference for isolator Side 1.
9	GND <sub>2</sub>	Ground 2. Ground reference for isolator Side 2.
10	V <sub>E2</sub>	Output Enable 2. Active high logic input. V <sub>Ox</sub> outputs on Side 2 are enabled when V <sub>E2</sub> is high or disconnected. V <sub>Ox</sub> Side 2 outputs are disabled when V <sub>E2</sub> is low. In noisy environments, connecting V <sub>E2</sub> to an external logic high or low is recommended.
11	V <sub>ID</sub>	Logic Input D.
12	V <sub>IC</sub>	Logic Input C.
13	V <sub>OB</sub>	Logic Output B.
14	V <sub>OA</sub>	Logic Output A.
15	GND <sub>2</sub>	Ground 2. Ground reference for isolator Side 2.
16	V <sub>DD2</sub>	Supply Voltage for Isolator Side 2, 2.7 V to 5.5 V.

### TYPICAL PERFORMANCE CHARACTERISTICS



Figure 8. Typical Input Supply Current per Channel vs. Data Rate (No Load)



Figure 11. Typical ADuM4400  $V_{DD1}$  Supply Current vs. Data Rate for 5 V and 3 V Operation



Figure 9. Typical Output Supply Current per Channel vs. Data Rate (No Load)



Figure 12. Typical ADuM4400  $V_{DD2}$  Supply Current vs. Data Rate for 5 V and 3 V Operation



Figure 10. Typical Output Supply Current per Channel vs. Data Rate (15 pF Output Load)



Figure 13. Typical ADuM4401  $V_{DD1}$  Supply Current vs. Data Rate for 5 V and 3 V Operation



Figure 14. Typical ADuM4401  $V_{DD2}$  Supply Current vs. Data Rate for 5 V and 3 V Operation



Figure 16. Propagation Delay vs. Temperature, C Grade



Figure 15. Typical ADuM4402  $V_{DD1}$  or  $V_{DD2}$  Supply Current vs. Data Rate for 5 V and 3 V Operation

## APPLICATIONS INFORMATION

### PC BOARD LAYOUT

The ADuM440x digital isolators require no external interface circuitry for the logic interfaces. Power supply bypassing is strongly recommended at the input and output supply pins (see Figure 17). Bypass capacitors are most conveniently connected between Pin 1 and Pin 2 for  $V_{DD1}$  and between Pin 15 and Pin 16 for  $V_{DD2}$ . The capacitor value should be between 0.01  $\mu\text{F}$  and 0.1  $\mu\text{F}$ . The total lead length between both ends of the capacitor and the input power supply pin should not exceed 20 mm. Bypassing between Pin 1 and Pin 8 and between Pin 9 and Pin 16 should also be considered unless the ground pair on each package side are connected close to the package.

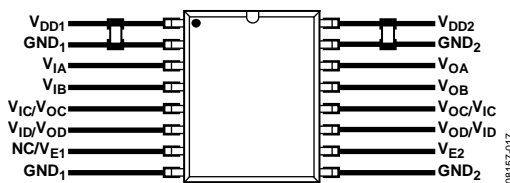


Figure 17. Recommended Printed Circuit Board Layout

In applications involving high common-mode transients, ensure that board coupling across the isolation barrier is minimized. Furthermore, the board layout should be designed such that any coupling that does occur equally affects all pins on a given component side. Failure to ensure this could cause voltage differentials between pins exceeding the Absolute Maximum Ratings of the device, thereby leading to latch-up or permanent damage.

See the [AN-1109 Application Note](#) for board layout guidelines.

### SYSTEM-LEVEL ESD CONSIDERATIONS AND ENHANCEMENTS

System-level ESD reliability (for example, per IEC 61000-4-x) is highly dependent on system design, which varies widely by application. The ADuM440x incorporate many enhancements to make ESD reliability less dependent on system design. The enhancements include

- ESD protection cells added to all input/output interfaces.
- Key metal trace resistances reduced using wider geometry and paralleling of lines with vias.
- The SCR effect, inherent in CMOS devices, minimized by using guarding and isolation techniques between PMOS and NMOS devices.
- Areas of high electric field concentration eliminated using 45° corners on metal traces.
- Supply pin overvoltage prevented with larger ESD clamps between each supply pin and its respective ground.

While the ADuM440x improve system-level ESD reliability, they are no substitute for a robust system-level design. See the [AN-793 Application Note](#), *ESD/Latch-Up Considerations with iCoupler Isolation Products*, for detailed recommendations on board layout and system-level design.

### PROPAGATION DELAY-RELATED PARAMETERS

Propagation delay is a parameter that describes the length of time for a logic signal to propagate through a component. The propagation delay to a logic low output can differ from the propagation delay to logic high.

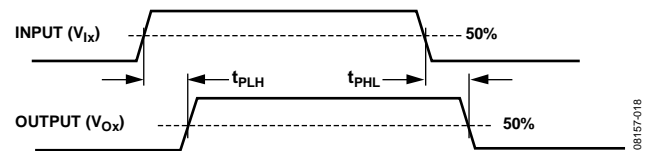


Figure 18. Propagation Delay Parameters

Pulse width distortion is the maximum difference between these two propagation delay values and is an indication of how accurately the input signal's timing is preserved.

Channel-to-channel matching refers to the maximum amount the propagation delay differs among channels within a single ADuM440x component.

Propagation delay skew refers to the maximum amount the propagation delay differs among multiple ADuM440x components operated under the same conditions.

### DC CORRECTNESS AND MAGNETIC FIELD IMMUNITY

Positive and negative logic transitions at the isolator input cause narrow ( $\sim 1$  ns) pulses to be sent via the transformer to the decoder. The decoder is bistable and is therefore either set or reset by the pulses, indicating input logic transitions. In the absence of logic transitions at the input for more than  $\sim 1$   $\mu\text{s}$ , a periodic set of refresh pulses indicative of the correct input state are sent to ensure dc correctness at the output. If the decoder receives no internal pulses for more than approximately 5  $\mu\text{s}$ , the input side is assumed to be without power or nonfunctional; in which case, the isolator output is forced to a default state (see Table 20) by the watchdog timer circuit.

The limitation on the ADuM440x magnetic field immunity is set by the condition in which induced voltage in the transformer's receiving coil is large enough to either falsely set or reset the decoder. The following analysis defines the conditions under which this can occur. The 3 V operating condition of the ADuM440x is examined because it represents the most susceptible mode of operation.

The pulses at the transformer output have an amplitude greater than 1.0 V. The decoder has a sensing threshold at about 0.5 V, thereby establishing a 0.5 V margin in which induced voltages can be tolerated. The voltage induced across the receiving coil is given by

$$V = (-d\beta/dt)\sum r_n^2; n = 1, 2, \dots, N$$

where:

$\beta$  is the magnetic flux density (gauss).

$N$  is the number of turns in the receiving coil.

$r_n$  is the radius of the  $n^{\text{th}}$  turn in the receiving coil (cm).

Given the geometry of the receiving coil in the ADuM440x and an imposed requirement that the induced voltage be at most 50% of the 0.5 V margin at the decoder, a maximum allowable magnetic field is calculated as shown in Figure 19.



Figure 19. Maximum Allowable External Magnetic Flux Density

For example, at a magnetic field frequency of 1 MHz, the maximum allowable magnetic field of 0.2 kgauss induces a voltage of 0.25 V at the receiving coil. This is about 50% of the sensing threshold and does not cause a faulty output transition. Similarly, if such an event were to occur during a transmitted pulse (and was of the worst-case polarity), it would reduce the received pulse from >1.0 V to 0.75 V—still well above the 0.5 V sensing threshold of the decoder.

The preceding magnetic flux density values correspond to specific current magnitudes at given distances away from the ADuM440x transformers. Figure 20 expresses these allowable current magnitudes as a function of frequency for selected distances. As can be seen, the ADuM440x are immune and can be affected only by extremely large currents operated at high frequency and very close to the component. For the 1 MHz example noted, one would have to place a 0.5 kA current 5 mm away from the ADuM440x to affect the component's operation.



Figure 20. Maximum Allowable Current for Various Current-to-ADuM440x Spacings

Note that at combinations of strong magnetic field and high frequency, any loops formed by printed circuit board traces may induce sufficiently large error voltages to trigger the thresholds of succeeding circuitry. Care should be taken in the layout of such traces to avoid this possibility.

**POWER CONSUMPTION**

The supply current at a given channel of the ADuM440x isolator is a function of the supply voltage, the channel's data rate, and the channel's output load.

For each input channel, the supply current is given by

$$I_{DDI} = I_{DDI(Q)} \quad f \leq 0.5f_r$$

$$I_{DDI} = I_{DDI(D)} \times (2f - f_r) + I_{DDI(Q)} \quad f > 0.5f_r$$

For each output channel, the supply current is given by

$$I_{DDO} = I_{DDO(Q)} \quad f \leq 0.5f_r$$

$$I_{DDO} = (I_{DDO(D)} + (0.5 \times 10^{-3}) \times C_L V_{DDO}) \times (2f - f_r) + I_{DDO(Q)} \quad f > 0.5f_r$$

where:

$I_{DDI(D)}$ ,  $I_{DDO(D)}$  are the input and output dynamic supply currents per channel (mA/Mbps).

$C_L$  is the output load capacitance (pF).

$V_{DDO}$  is the output supply voltage (V).

$f$  is the input logic signal frequency (MHz, half of the input data rate, NRZ signaling).

$f_r$  is the input stage refresh rate (Mbps).

$I_{DDI(Q)}$ ,  $I_{DDO(Q)}$  are the specified input and output quiescent supply currents (mA).



To calculate the total  $I_{DD1}$  and  $I_{DD2}$ , the supply currents for each input and output channel corresponding to  $I_{DD1}$  and  $I_{DD2}$  are calculated and totaled. Figure 8 and Figure 9 provide per channel supply currents as a function of data rate for an unloaded output condition. Figure 10 provides per channel supply current as a function of data rate for a 15 pF output condition. Figure 11 through Figure 15 provide total  $I_{DD1}$  and  $I_{DD2}$  as a function of data rate for ADuM4400/ADuM4401/ADuM4402 channel configurations.

## INSULATION LIFETIME

All insulation structures eventually break down when subjected to voltage stress over a sufficiently long period. The rate of insulation degradation is dependent on the characteristics of the voltage waveform applied across the insulation. In addition to the testing performed by the regulatory agencies, Analog Devices carries out an extensive set of evaluations to determine the lifetime of the insulation structure within the ADuM440x.

Analog Devices performs accelerated life testing using voltage levels higher than the rated continuous working voltage. Acceleration factors for several operating conditions are determined. These factors allow calculation of the time to failure at the actual working voltage. The values shown in Table 19 summarize the peak voltage for 50 years of service life for a bipolar ac operating condition and the maximum CSA/VDE approved working voltages. In many cases, the approved working voltage is higher than the 50-year service life voltage. Operation at these high working voltages can lead to shortened insulation life in some cases.

The insulation lifetime of the ADuM440x depends on the voltage waveform type imposed across the isolation barrier. The iCoupler insulation structure degrades at different rates, depending on whether the waveform is bipolar ac, unipolar ac, or dc. Figure 21, Figure 22, and Figure 23 illustrate these different isolation voltage waveforms.

Bipolar ac voltage is the most stringent environment. The goal of a 50-year operating lifetime under the ac bipolar condition determines Analog Devices recommended maximum working voltage.

In the case of unipolar ac or dc voltage, the stress on the insulation is significantly lower. This allows operation at higher working voltages while still achieving a 50-year service life. The working voltages listed in Table 19 can be applied while maintaining the 50-year minimum lifetime, provided the voltage conforms to either the unipolar ac or dc voltage cases. Any cross-insulation voltage waveform that does not conform to Figure 22 or Figure 23 should be treated as a bipolar ac waveform, and its peak voltage should be limited to the 50-year lifetime voltage value listed in Table 19.

Note that the voltage presented in Figure 22 is shown as sinusoidal for illustration purposes only. It is meant to represent any voltage waveform varying between 0 V and some limiting value. The limiting value can be positive or negative, but the voltage cannot cross 0 V.



Figure 21. Bipolar AC Waveform

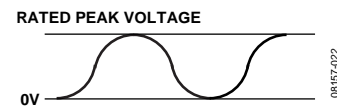


Figure 22. Unipolar AC Waveform

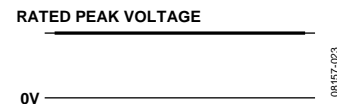


Figure 23. DC Waveform

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-013-AA  
 CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS  
 (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR  
 REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 24. 16-Lead Standard Small Outline Package [SOIC\_W]  
 Wide Body (RW-16)  
 Dimensions shown in millimeters and (inches)

03-27-2007-B



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 REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 25. 16-Lead Standard Small Outline Package, with Increased Creepage [SOIC\_IC]  
 Wide Body (RI-16-1)  
 Dimension shown in millimeters and (inches)

10-12-2010-A

## ORDERING GUIDE

Model <sup>1, 2</sup>	Number of Inputs, V <sub>DD1</sub> Side	Number of Inputs, V <sub>DD2</sub> Side	Maximum Data Rate (Mbps)	Maximum Propagation Delay, 5 V (ns)	Maximum Pulse Width Distortion (ns)	Temperature Range	Package Description	Package Option
ADuM4400ARWZ	4	0	1	100	40	−40°C to +105°C	16-Lead SOIC_W	RW-16
ADuM4400BRWZ	4	0	10	50	3	−40°C to +105°C	16-Lead SOIC_W	RW-16
ADuM4400CRWZ	4	0	90	32	2	−40°C to +105°C	16-Lead SOIC_W	RW-16
ADuM4400ARIZ	4	0	1	100	40	−40°C to +105°C	16-Lead SOIC_IC	RI-16-1
ADuM4400BRIZ	4	0	10	50	3	−40°C to +105°C	16-Lead SOIC_IC	RI-16-1
ADuM4400CRIZ	4	0	90	32	2	−40°C to +105°C	16-Lead SOIC_IC	RI-16-1
ADuM4401ARWZ	3	1	1	100	40	−40°C to +105°C	16-Lead SOIC_W	RW-16
ADuM4401BRWZ	3	1	10	50	3	−40°C to +105°C	16-Lead SOIC_W	RW-16
ADuM4401CRWZ	3	1	90	32	2	−40°C to +105°C	16-Lead SOIC_W	RW-16
ADuM4401ARIZ	3	1	1	100	40	−40°C to +105°C	16-Lead SOIC_IC	RI-16-1
ADuM4401BRIZ	3	1	10	50	3	−40°C to +105°C	16-Lead SOIC_IC	RI-16-1
ADuM4401CRIZ	3	1	90	32	2	−40°C to +105°C	16-Lead SOIC_IC	RI-16-1
ADuM4402ARWZ	2	2	1	100	40	−40°C to +105°C	16-Lead SOIC_W	RW-16
ADuM4402BRWZ	2	2	10	50	3	−40°C to +105°C	16-Lead SOIC_W	RW-16
ADuM4402CRWZ	2	2	90	32	2	−40°C to +105°C	16-Lead SOIC_W	RW-16
ADuM4402ARIZ	2	2	1	100	40	−40°C to +105°C	16-Lead SOIC_IC	RI-16-1
ADuM4402BRIZ	2	2	10	50	3	−40°C to +105°C	16-Lead SOIC_IC	RI-16-1
ADuM4402CRIZ	2	2	90	32	2	−40°C to +105°C	16-Lead SOIC_IC	RI-16-1

<sup>1</sup> Tape and reel is available. The addition of an -RL suffix designates a 13" (1,000 units) tape and reel option.

<sup>2</sup> Z = RoHS Compliant Part.

**NOTES**



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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